

Thermally-Enhanced High Power RF GaN HEMT 170 W, 50 V, 2620 – 2690 MHz

Description

The GTVA261701FA is a 170-watt (P_{3dB}) GaN high electron mobility transistor (HEMT) for use in multi-standard cellular power amplifier applications. It features input matching, high efficiency, and a thermally-enhanced package with earless flange.

Advance Specification Data Sheets describe products that are being considered by Infineon for development and market introduction. The target performance shown in Advance Specifications is not final and should not be used for any design activity. Please contact Infineon about the future availability of these products.

Features

- Input Matched
- Typical Pulsed CW performance, 2690 MHz, 48 V, single side
 - Output power at $P_{3dB} = 170$ W
 - Efficiency = 72%
 - Gain = 16 dB
- GaN HEMT technology
- High power density
- High efficiency
- RoHS-compliant



GTVA261701FA
Package H-37265J-2

advance specification

Target RF Characteristics

Single-carrier WCDMA Specifications (tested in Infineon test fixture)

$V_{DD} = 48$ V, $I_{DQ} = 200$ mA, $P_{OUT} = 50$ W avg, $f_1 = 2620$ MHz, $f_2 = 2690$ MHz, channel bandwidth = 3.84 MHz, peak/average = 10 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	G_{ps}	—	18	—	dB
Drain Efficiency	η_D	—	47	—	%
Adjacent Channel Power Ratio	ACPR	—	-29	—	dBc

All published data at $T_{CASE} = 25^\circ\text{C}$ unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

DC Characteristics (measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-source Breakdown Voltage	$V_{GS} = -8\text{ V}$, $I_D = 32\text{ mA}$	$V_{(BR)DSS}$	150	—	—	V
Gate Threshold Voltage	$V_{DS} = 10\text{ V}$, $I_D = 32\text{ mA}$	$V_{GS(th)}$	-3.8	-3.0	-2.3	V
Gate Quiescent Voltage	$V_{DS} = 50\text{ V}$, $I_D = 1.0\text{ A}$	$V_{GS(Q)}$	—	-2.8	—	V
Saturated Drain Current	$V_{DS} = 6.0\text{ V}$, $V_{GS} = 2.0\text{ V}$	I_{DS}	15	18	—	A

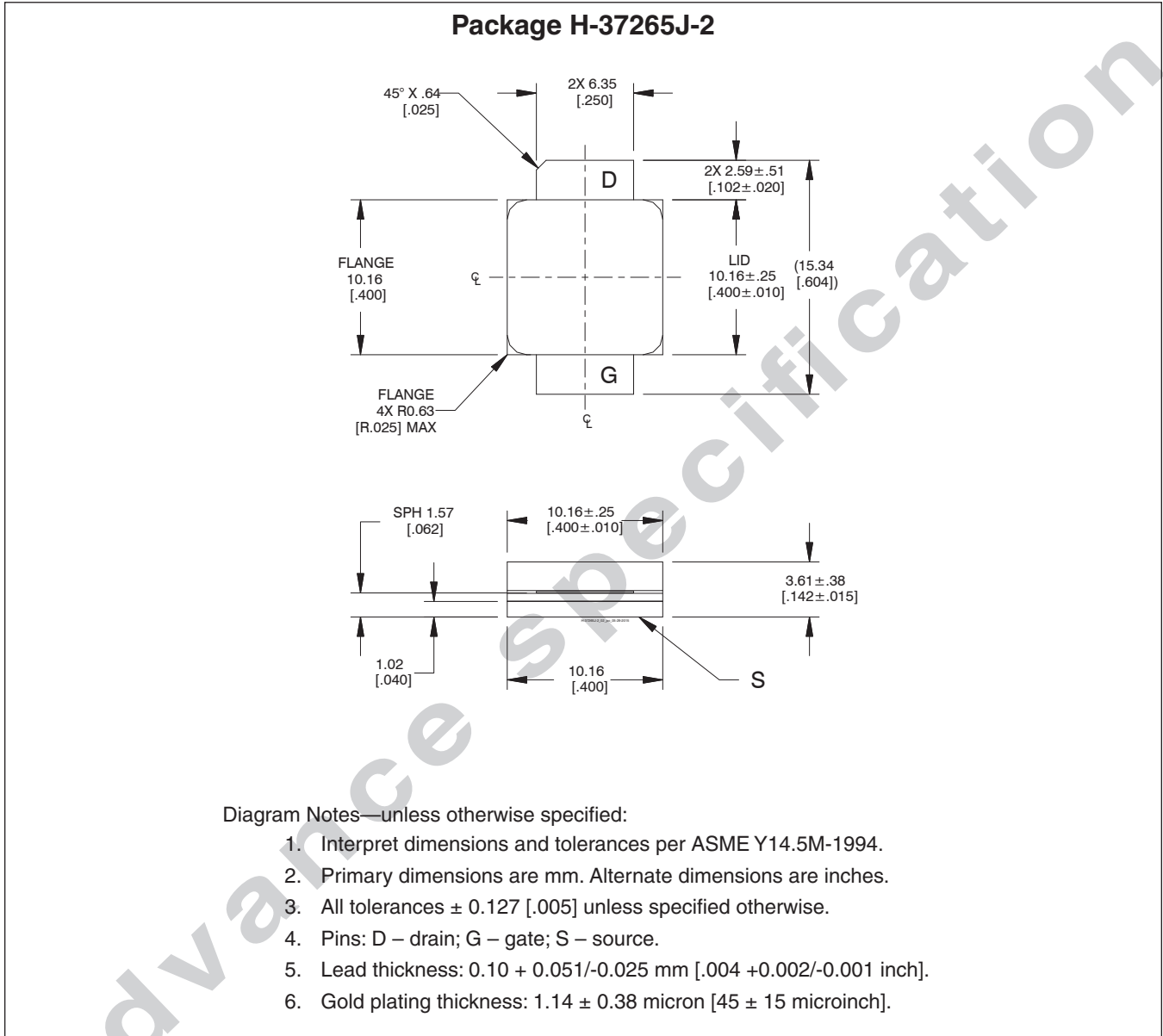
Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source Voltage	V_{DSS}	125	V
Gate-source Voltage	V_{GS}	-10 to +2	V
Operating Voltage	V_{DD}	0 to +50	V
Gate Current	I_G	20	mA
Drain Current	I_D	7.5	A
Junction Temperature	T_J	225	°C
Storage Temperature Range	T_{STG}	-65 to +150	°C
Thermal Resistance	$R_{\theta JC}$	TBD	°C/W

Ordering Information

Type and Version	Order Code	Package Description	Shipping
GTVA261701FA V1	TBD	H-37265J-2, earless flange	Tray
GTVA261701FA V1 R250	TBD	H-37265J-2,, earless flange	Tape & Reel, 250 pcs

Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page <http://www.infineon.com/rfpower>